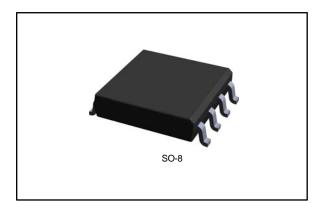




Programmable transient voltage suppressor for SLIC protection

Datasheet - production data



Features

- Programmable transient suppressor
- Wide negative firing voltage range:
 V_{Gn} = -175 V max.
- Low dynamic switching voltages:
 V_{FP} and V_{DGL}
- Low gate triggering current: I_{GT} = 5 mA max.
- Peak pulse current: IPP = 40 A (5/310 µs)
- Holding current: I_H = 150 mA min.

Benefits

- A Trisil™ is not subject to ageing and provides a fail-safe mode in short circuit for a better protection.
- Trisils are used to help equipment to meet various standards such as UL60950, IEC 60950 / CSA C22.2, UL1459 and TIA-968-A (formerly FCC part 68)
- Trisils have UL94 V0 resin approved (Trisils are UL497B approved file: E136224)

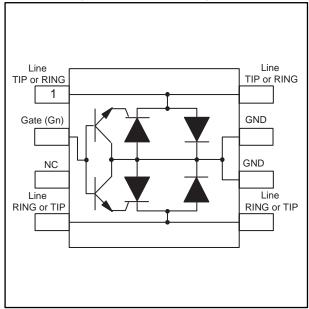
Description

These devices have been especially designed to protect new high voltage, as well as classical SLICs, against transient overvoltages.

Positive overvoltages are clamped by 2 diodes. Negative surges are suppressed by 2 thyristors, their breakdown voltage being referenced to -V_{BAT} through the gate.

These components present a very low gate triggering current (IGT) in order to reduce the current consumption on printed circuit board during the firing phase.

Figure 1: Functional diagram



Characteristics LCP1521S

1 Characteristics

Table 1: Standards compliance

Standard	Peak surge voltage (V)	Voltage waveform	Required peak current (A)	Current waveform	Minimum serial resistor to meet standard (Ω)
GR-1089 Core First level	2500 1000	2/10 μs 10/1000 μs	500 100	2/10 μs 10/1000 μs	12 24
GR-1089 Core Second level	5000	2/10 μs	500	2/10 μs	24
GR-1089 Core Intra-building	1500	2/10 µs	100	2/10 μs	0
ITU-T-K20/K21	6000 1500	10/700 μs	150 37.5	5/310 µs	110 0
ITU-T-K20 (IEC 61000-4-2)	8000 15000	1/60 ns	ESD contact discharge ESD air discharge		0 0
IEC 61000-4-5	4000 4000	10/700 μs 1.2/50 μs	100 100	5/310 μs 8/20 μs	60 0
TIA-968-A, lightning surge type A	1500 800	10/160 μs 10/560 μs	200 100	10/160 μs 10/560 μs	22.5 15
TIA-968-A, lightning surge type B	1000	9/720 µs	25	5/320 µs	0

Table 2: Thermal resistances

Symbol	Parameter	Value	Unit
R _{th(j-a)}	Junction to ambient	120	°C/W

LCP1521S Characteristics

Table 3: Absolute ratings (T_j = 25 °C, unless otherwise specified)

Symbol		Parameter		Value	Unit	
		Telcordia GR-1089-CORE Issue 6, May 2011, section 4	10/1000 µs	30		
		TIA-968-A, lightning surge type A	10/560 μs	35		
		ITU-T K20/21/44/45, (10/700 µs open circuit voltage waveshape)	5/310 µs	40		
	Peak pulse	TIA-968-A, lightning surge type A	10/160 μs	50	A	
	current ⁽¹⁾	IEC 61000-4-5, (1.2/50 μs open circuit waveshape) with 10 Ω	4/30 µs	110		
		ITU-T K20/21/44/45, (1.2/50 µs open circuit voltage waveshape)	8/20 µs	120		
		Telcordia GR-1089-CORE Issue 6, (2/10 µs open circuit waveshape)	2/10 μs	150		
			t = 20 ms	18		
ITSM	Non repetitive surge peak on-state current (50 Hz sinusoidal) $t = 200 \text{ r}$			10	Α	
	t = 1 s		t = 1 s	7		
$V_{\sf GN}$	Negative battery voltage range -40 °C < T _{amb} < +85 °C		-175	V		
T _{stg}	Storage junction temperature range					
Tj	Operating junction temperature range					
TL	Maximum temperature for soldering during 10 s 260 °C					

Notes:

⁽¹⁾The rated current values may be applied either to the Ring to GND or to the Tip to GND terminal pairs. Additionally, the four terminal pairs may have their rated current values applied simultaneously (in this case the GND terminal current will be four times the rated current value of an individual terminal pair). Both GND pins must be connected to GND.

Characteristics LCP1521S

Figure 2: Electrical characteristics (definitions)

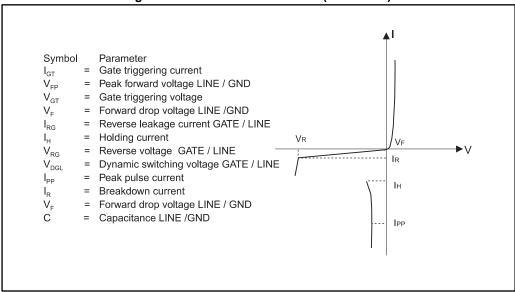
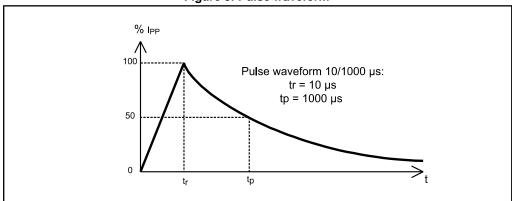


Figure 3: Pulse waveform



LCP1521S Characteristics

Table 4: Parameters ($T_j = 25$ °C, unless otherwise specified)

Symbol		Test conditions						Max.	Unit
lgт	V _{LINE} = -48 V					0.1		5	mA
Ін	V _{Gn} = -48 V					150			mA
V _{GT}	at I _{GT}							2.5	V
I _{RG}	V _{RG} = -175 V V _{RG} = -175 V				$T_j = 25 ^{\circ}\text{C}$ $T_j = 85 ^{\circ}\text{C}$			5 50	μA
		10/700 µs	1.5 kV	R _S = 10 Ω	I _{PP} = 30 A			7	
V _{DGL} (1)	V _{Gn} = -48 V	1.2/50 µs	1.5 kV	R _S = 10 Ω	I _{PP} = 30 A			10	V
		2/10 µs	2.5 kV	R _S = 62 Ω	I _{PP} = 38 A			25	
VF	l _F =	1 A		t = 500 µs	3			3	V
	1	0/700 μs		1.5 kV	R _S = 10 Ω			5	
V _{FP}		1.2/50 µs		1.5 kV	Rs = 10 Ω			9	V
		2/10 μs	2.5 kV	R _S = 62 Ω			30		
I _R	V _{Gn / LINE} = -1 V, V _{LINE} = -175 V V _{Gn / LINE} = -1 V, V _{LINE} = -175 V				$T_j = 25 ^{\circ}\text{C}$ $T_j = 85 ^{\circ}\text{C}$			5 50	μΑ
С	V _{LINE} = -50 V V _{LINE} = -2 V,			Z			15 35		pF

Notes:

Table 5: Recommended gate capacitance

Symbol	Component	Min.	Тур.	Max.	Unit
C _G	Gate decoupling capacitance	100	220		nF

 $^{^{(1)}}$ The oscillations with a time duration lower than 50 ns are not taken into account.

Technical information LCP1521S

2 Technical information

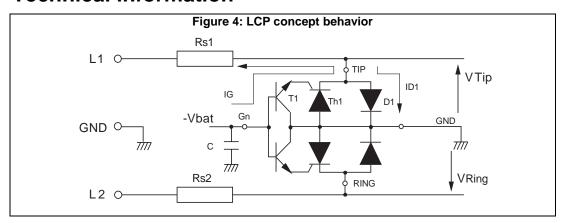


Figure 4: "LCP concept behavior" shows the classical protection circuit using the LCP crowbar concept. This topology has been developed to protect the new high voltage SLICs. It allows to program the negative firing threshold while the positive clamping value is fixed at GND.

When a negative surge occurs on one wire (L1 for example) a current IG flows through the base of the transistor T1 and then injects a current in the gate of the thyristor Th1. Th1 fires and all the surge current flows through the ground. After the surge when the current flowing through Th1 becomes less negative than the holding current IH, then Th1 switches off.

When a positive surge occurs on one wire (L1 for example) the diode D1 conducts and the surge current flows through the ground.

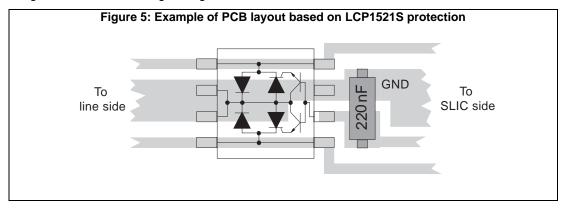


Figure 5: "Example of PCB layout based on LCP1521S protection" shows the classical PCB layout used to optimize line protection.

The capacitor C is used to speed up the crowbar structure firing during the fast surge edges.

This allows minimization of the dynamic breakover voltage at the SLIC Tip and Ring inputs during fast strikes. Note that this capacitor is generally present around the SLIC - V_{bat} pin.

So to be efficient it has to be as close as possible from the LCP Gate pin and from the reference ground track (or plan) (see *Figure 5: "Example of PCB layout based on LCP1521S protection"*). The optimized value for C is 220 nF.

LCP1521S Technical information

The series resistors Rs1 and Rs2 designed in *Figure 4: "LCP concept behavior"* represent the fuse resistors or the PTC which are mandatory to withstand the power contact or the power induction tests imposed by the various country standards. Taking into account this fact the actual lightning surge current flowing through the LCP is equal to:

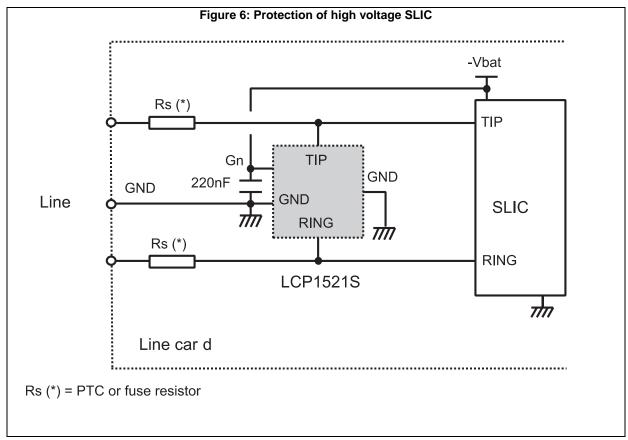
- I surge = V surge / $(R_g + R_s)$ with:
 - V surge = peak surge voltage imposed by the standard.
 - R_a = series resistor of the surge generator
 - R_s = series resistor of the line card (e.g. PTC)

E.g. For a line card with 30 Ω of series resistors which has to be qualified under GR1089 core 1000V 10/1000 μ s surge, the actual current through the LCP is equal to:

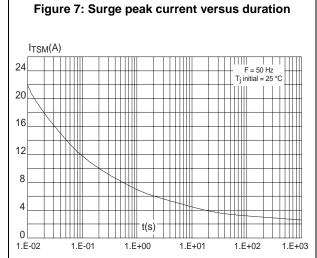
• I surge = 1000 / (10 + 30) = 25 A

The LCP is particularly optimized for the new telecom applications such as the fiber in the loop, the WLL, the remote central office. In this case, the operating voltages are smaller than in the classical system. This makes the high voltage SLICs particularly suitable.

The schematics of *Figure 6: "Protection of high voltage SLIC"* give the most frequent topology used for these applications.



Technical information LCP1521S



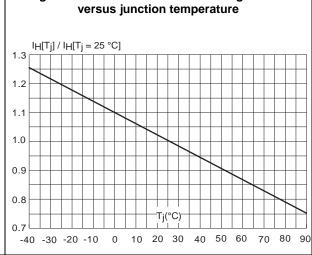


Figure 8: Relative variation of holding current

LCP1521S Package information

3 **Package information**

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

SO-8 package information 3.1

□ ccc C 8 П п 4 1

Figure 9: SO-8 package outline

Table 6: SO-8 package mechanical data

			Dir	mensions		
Ref.		Millimeters			Inches	
	Min.	Тур.	Max.	Min.	Тур.	Max.
А			1.75			0.069
A1	0.1		0.25	0.004		0.010
A2	1.25			0.049		
b	0.31		0.51	0.012		0.020
С	0.10		0.25	0.004		0.010
D	4.80	4.90	5.00	0.189	0.193	0.197
Е	5.80	6.00	6.20	0.228	0.236	0.244
E1	3.80	3.90	4.00	0.150	0.154	0.157
е		1.27			0.050	
h	0.25		0.50	0.010		0.020
L	0.40		1.27	0.016		0.05
L1		1.04			0.041	
k°	0		8	0		8
ccc			0.10			0.004

Package information LCP1521S

Figure 10: Footprint recommendations, dimensions in mm (inches)

Figure 11: Marking layout (refer to ordering information table for marking)

Chamfer indicates pin 1

XXXXXX

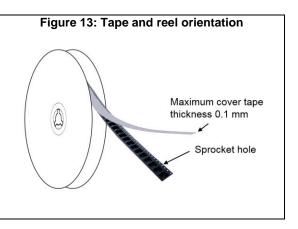
XXXXXX: Marking
ZZ: Manufacturing location
Y: Year
WW: week

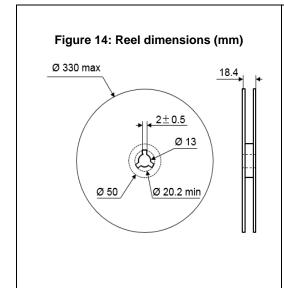
Figure 12: Package orientation in reel

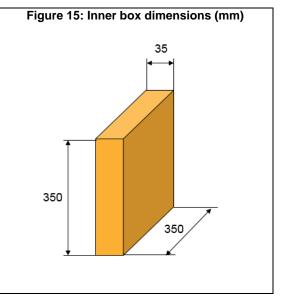
Pin 1

Taped according to EIA-481

Note: Pocket dimensions are not on scale
Pocket shape may vary depending on package







LCP1521S Package information

Figure 16: Tape and reel outline

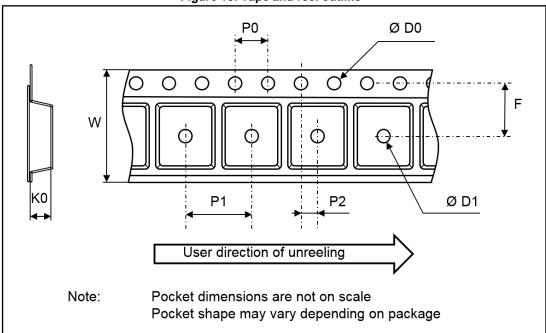


Table 7: Tape and reel mechanical data

	Dimensions						
Ref.	Millimeters						
	Min.	Тур.	Max.				
P0	3.9	4	4.1				
P1	7.9	8	8.1				
P2	1.95	2	2.05				
ØD0	1.45	1.5	1.6				
ØD1	1.6						
F	5.45	5.5	5.55				
K0	2.5	2.6	2.7				
W	11.7	12	12.3				

Package information LCP1521S

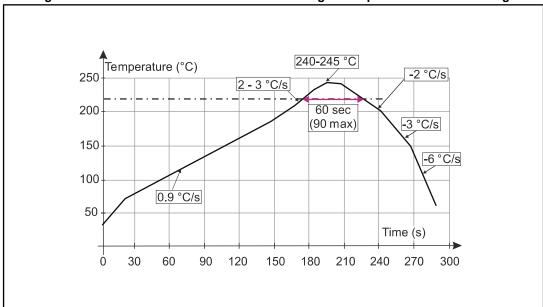


Figure 17: ST ECOPACK® recommended soldering reflow profile for PCB mounting



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Minimize air convection currents in the reflow oven to avoid component movement. Maximum soldering profile corresponds to the latest IPC/JEDEC J-STD-020.

LCP1521S Ordering information

4 Ordering information

Table 8: Ordering information

Order code	Marking	Package	Weight	Base qty.	Delivery mode
LCP1521SRL	CP152S	SO-8	0.08 g	2500	Tape and reel

5 Revision history

Table 9: Document revision history

Date	Revision	Changes	
20-Nov-2009	1	First issue.	
23-Feb-2012	2	Standardized nomenclature for Gn.	
15-Nov-2013	3	Updated Figure 9.	
10-Apr-2015	4	Updated Figure 1, Figure 10 and package view. Added Figure 11. Updated Table 3 and Table 7.	
02-Jul-2015	5	Updated package information.	
08-Jul-2015	6	Updated Figure 9.	
12-Dec-2017	7	Updated Table 3: "Absolute ratings ($T_j = 25$ °C, unless otherwise specified)" and Section 3: "Package information".	

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